505444191 04/24/2019

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHENGBO CHEN	04/22/2019
TAO LUO	02/15/2019
SUMEETH NAGARAJA	02/18/2019
XIAO FENG WANG	02/13/2019
SONY AKKARAKARAN	02/13/2019
MAKESH PRAVIN JOHN WILSON	02/12/2019
WOOSEOK NAM	02/12/2019
KAUSHIK CHAKRABORTY	02/12/2019
JUAN MONTOJO	02/12/2019

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number		
Application Number:	16104369		

CORRESPONDENCE DATA

Fax Number: (713)623-4846

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 713-623-4844

Email: cstepanek@pattersonsheridan.com,

psdocketing@pattersonsheridan.com

Correspondent Name: PATTERSON & SHERIDAN, LLP

Address Line 1: 24 GREENWAY PLAZA

Address Line 2: **SUITE 1600**

Address Line 4: HOUSTON, TEXAS 77046

ATTORNEY DOCKET NUMBER: 175955US

> **PATENT** REEL: 048986 FRAME: 0437

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NAME OF SUBMITTER:	ANKUR GARG	
SIGNATURE:	/Ankur Garg/	
DATE SIGNED:	04/24/2019	
Total Attachments: 6		
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ASSIGNMENT

WHEREAS, WE,

- 1. Shengbo CHEN, a citizen of the People's Republic of China, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Diego, California,
- 2. Tao LUO, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Diego, California.
- 3. Sumeeth NAGARAJA, a citizen of India, having a mailing address located at 4441 Calle Mar De Armonia; San Diego, California 92130 and a resident of San Diego, California,
- 4. Xiao Feng WANG, a citizen of Canada, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Diego, California,
- 5. Sony AKKARAKARAN, a citizen of India, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of Poway, California,
- 6. Makesh Pravin JOHN WILSON, a citizen of India, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Diego, California.
- 7. Wooseok NAM, a citizen of the Republic of Korea, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Diego, California,
- 8. Kaushik CHAKRABORTY, a citizen of India, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Diego, California,
- 9. Juan MONTOJO, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **UPLINK POWER CONTROL** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, Qualcomm Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, or under International Conventions, Treaties, or Agreements, U.S. Application No. 16/104,369 filed August 17, 2018, Qualcomm Reference No. 175955, and all provisional applications relating thereto, together with U.S. Provisional Application No. 62/547,333, filed August 18, 2017, Qualcomm Reference No. 175855P1, and divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	LOCATION	, on	4/22/20/9 DATE	Shengbo CHEN
Done at _	LOCATION	, on	DATE	Tao LUO
Done at _	LOCATION	, on	DATE	Sumeeth NAGARAJA
Done at ,	LOCATION	, on	DATE	Xiao Feng WANG
Done at	LOCATION	, on	DATE	Sony AKKARAKARAN

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on		
LOCATION		DATE	Shengbo CHEN
Done at LOCATION	, on	OZ/15/2018 DATE	Tão LUO
Done atLOCATION	, on	DATE	Sumeeth NAGARAJA
Done at San Dieso	, on	02/13/2019 DATE	Xiao Feng WANG
Done at Share Scale	, on	2/13/2019 DATE	Sony AKKARAKARAN

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on		
	LOCATION		DATE	Shengbo CHEN
Done at	LOCATION	, on	DATE	Tao LUO
Done at	Sun Digo LOCATION	, on	Feb 18 2019 DATE	Sumeeth NAGARAJA
Done at	LOCATION	, on	DATE	Xiao Feng WANG
Done at	LOCATION	, on	DATE	Sony AKKARAKARAN

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on O2/12/19

Done at San Diego, on DATE

PATENT REEL: 048986 FRAME: 0444

RECORDED: 04/24/2019